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What is "**Embedded - Microcontrollers**"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "**Embedded - Microcontrollers**"

| Details	
Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	HLVD, POR, WDT
Number of I/O	24
Program Memory Size	4KB (4K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	237 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/zgp323lah2804g
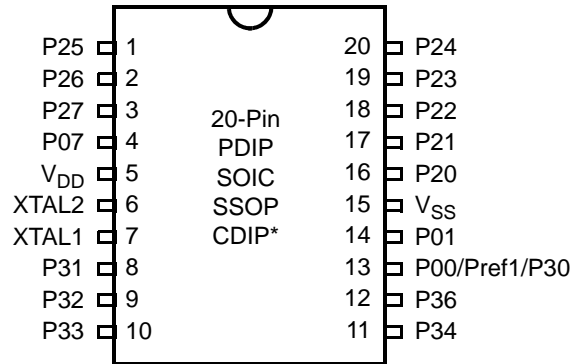
Figure 3. 20-Pin PDIP/SOIC/SSOP/CDIP* Pin Configuration

Table 3. 20-Pin PDIP/SOIC/SSOP/CDIP* Pin Identification

Pin #	Symbol	Function	Direction
1–3	P25–P27	Port 2, Bits 5,6,7	Input/Output
4	P07	Port 0, Bit 7	Input/Output
5	V_{DD}	Power Supply	
6	XTAL2	Crystal Oscillator Clock	Output
7	XTAL1	Crystal Oscillator Clock	Input
8–10	P31–P33	Port 3, Bits 1,2,3	Input
11,12	P34. P36	Port 3, Bits 4,6	Output
13	P00/Pref1/P30	Port 0, Bit 0/Analog reference input Port 3 Bit 0	Input/Output for P00 Input for Pref1/P30
14	P01	Port 0, Bit 1	Input/Output
15	V_{SS}	Ground	
16–20	P20–P24	Port 2, Bits 0,1,2,3,4	Input/Output

▶ **Note:** *Windowed Cerdip. These units are intended to be used for engineering code development only. ZiLOG does not recommend/guarantee this package for production use.

Table 8. DC Characteristics (Continued)

Symbol	Parameter	V_{CC}	T_A= 0°C to +70°C			Units	Conditions	Notes
			Min	Typ	Max			
I_{CC1}	Standby Current	2.0			3	mA	V_{IN} = 0V, V_{CC} at 8.0MHz	1, 2
	(HALT Mode)	3.6			5		Same as above	1, 2
		2.0			2		Clock Divide-by-16 at 8.0MHz	1, 2
		3.6			4		Same as above	1, 2
I_{CC2}	Standby Current (Stop	2.0			8	µA	V_{IN} = 0 V, V_{CC} WDT is not Running	3
	Mode)	3.6			10	µA	Same as above	3
		2.0			500	µA	V_{IN} = 0 V, V_{CC} WDT is Running	3
		3.6			800	µA	Same as above	3
I_{LV}	Standby Current (Low Voltage)				10	µA	Measured at 1.3V	4
V_{BO}	V_{CC} Low Voltage Protection				2.0	V	8MHz maximum Ext. CLK Freq.	
V_{LVD}	Vcc Low Voltage Detection			2.4		V		
V_{HVD}	Vcc High Voltage Detection			2.7		V		

Notes:
1. All outputs unloaded, inputs at rail.
2. CL1 = CL2 = 100 pF.
3. Oscillator stopped.
4. Oscillator stops when V_{CC} falls below V_{BO} limit.
5. It is strongly recommended to add a filter capacitor (minimum 0.1 µF), physically close to the V_{DD} and V_{SS} pins if oper-
   ating voltage fluctuations are anticipated, such as those resulting from driving an Infrared LED.

AC Characteristics

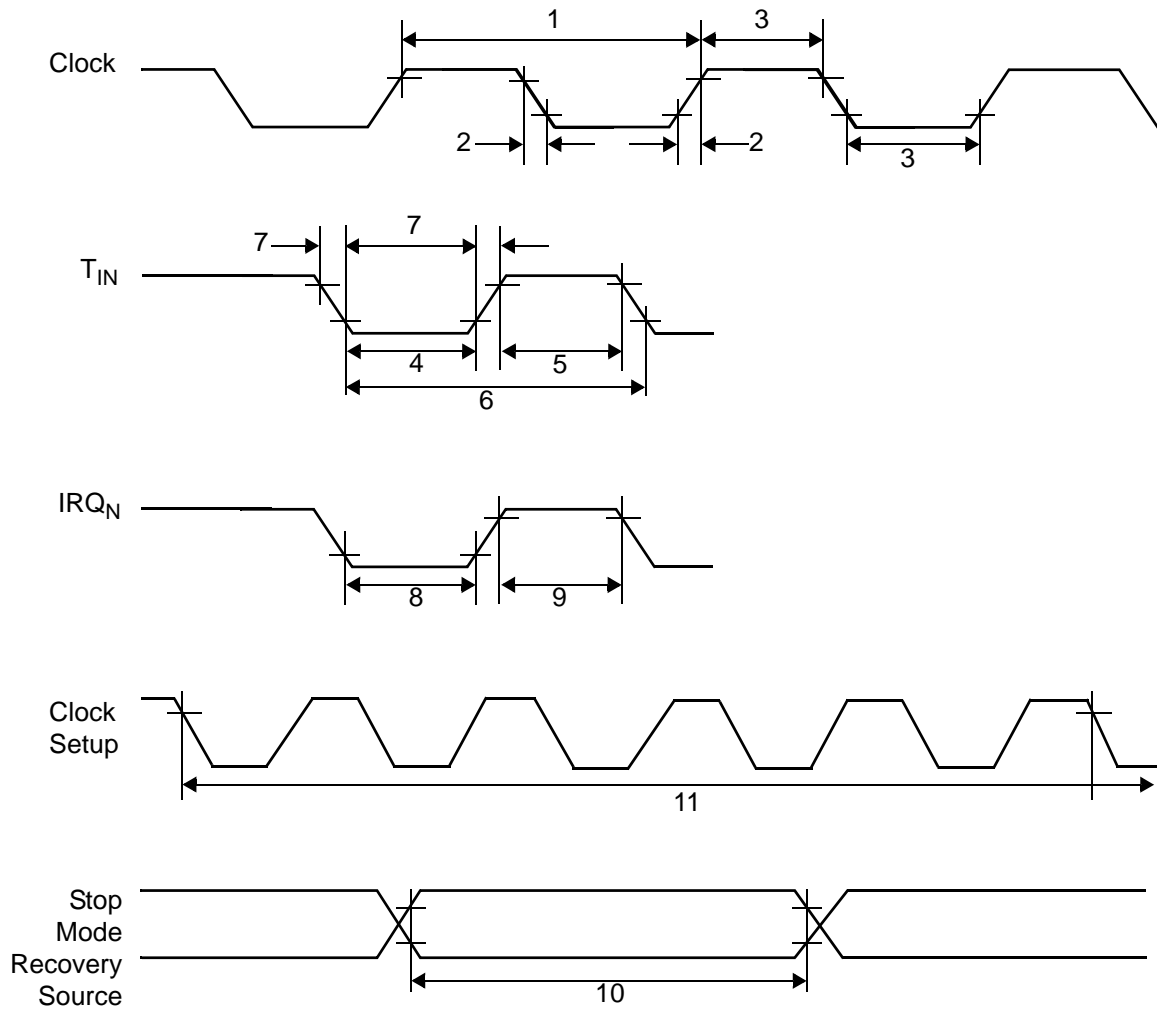Figure 8 and Table 10 describe the Alternating Current (AC) characteristics.
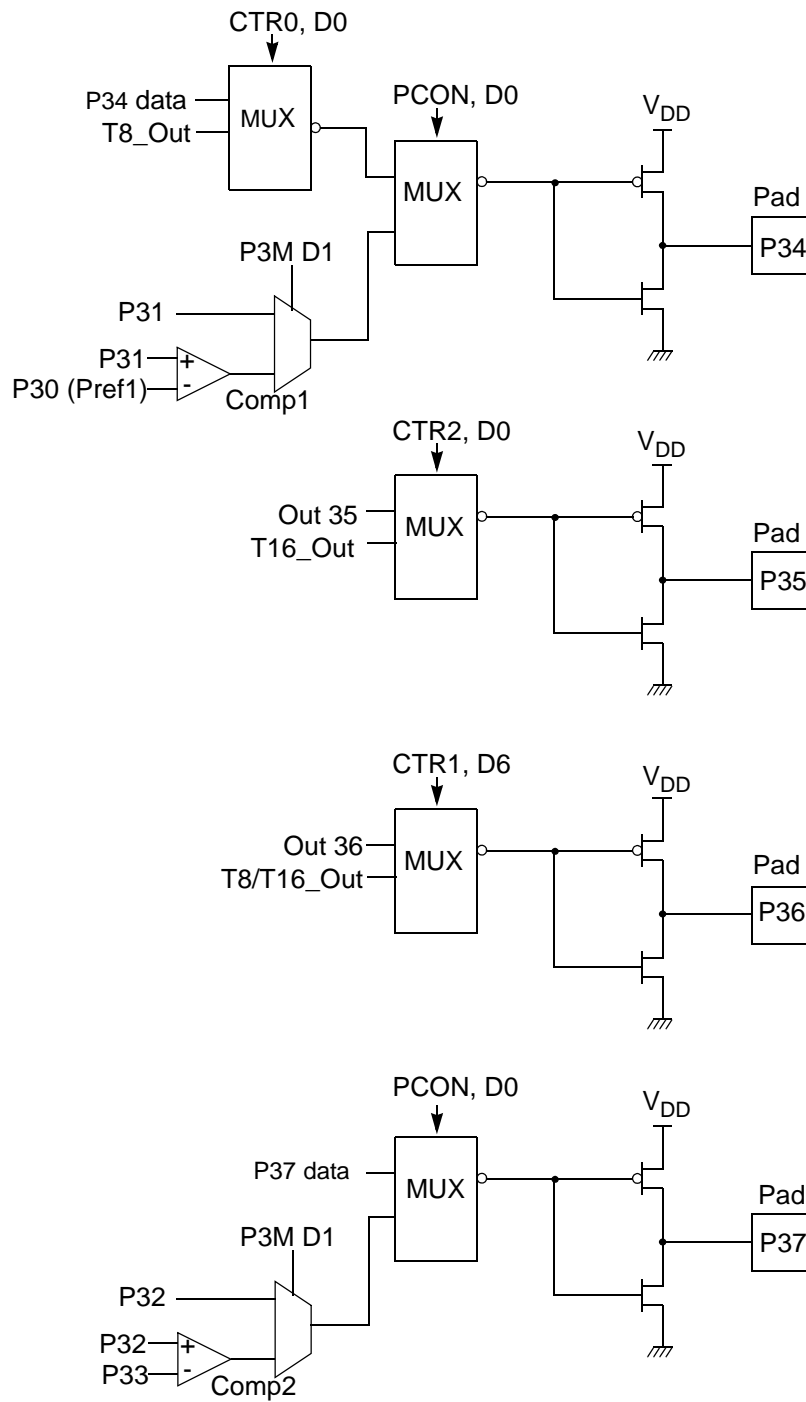

Figure 8. AC Timing Diagram
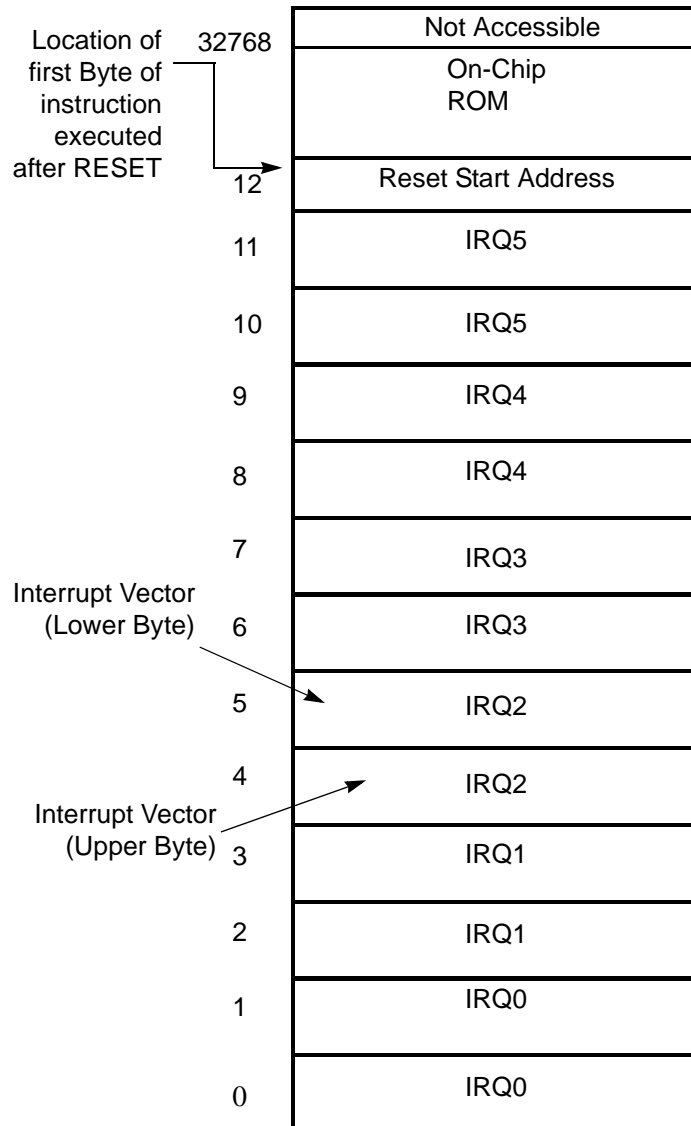
Figure 13. Port 3 Counter/Timer Output Configuration

32768	Not Accessible
	On-Chip ROM
12	Reset Start Address
11	IRQ5
10	IRQ5
9	IRQ4
8	IRQ4
7	IRQ3
6	IRQ3
5	IRQ2
4	IRQ2
3	IRQ1
2	IRQ1
1	IRQ0
0	IRQ0

Location of first Byte of instruction executed after RESET

Interrupt Vector (Lower Byte)

Interrupt Vector (Upper Byte)

Figure 14. Program Memory Map (32K OTP)

Expanded Register File

The register file has been expanded to allow for additional system control registers and for mapping of additional peripheral devices into the register address area. The Z8® register address space (R0 through R15) has been implemented as 16 banks, with 16 registers per bank. These register groups are known as the

ERF (Expanded Register File). Bits 7–4 of register RP select the working register group. Bits 3–0 of register RP select the expanded register file bank.

▶ **Note:** An expanded register bank is also referred to as an expanded register group (see Figure 15).

The counter/timers are mapped into ERF group D. Access is easily performed using the following:

```
LD                      RP, #0Dh                    ; Select ERF D
for access to bank D
                                                    ; (working
register group 0)
LD                      R0,#xx                      ; load CTRL0
LD                      1, #xx                       ; load CTRL1
LD                      R1, 2                       ; CTRL2→CTRL1

LD                      RP, #0Dh                    ; Select ERF D
for access to bank D
                                                    ; (working
register group 0)
LD                      RP, #7Dh                    ; Select
expanded register bank D and working               ; register
group 7 of bank 0 for access.
LD                      71h, 2
; CTRL2→register 71h
LD                      R1, 2
; CTRL2→register 71h
```

Register File

The register file (bank 0) consists of 4 I/O port registers, 237 general-purpose registers, 16 control and status registers (R0–R3, R4–R239, and R240–R255, respectively), and two expanded registers groups in Banks D (see Table 12) and F. Instructions can access registers directly or indirectly through an 8-bit address field, thereby allowing a short, 4-bit register address to use the Register Pointer (Figure 17). In the 4-bit mode, the register file is divided into 16 working register groups, each occupying 16 continuous locations. The Register Pointer addresses the starting location of the active working register group.

▶ **Note:** Working register group E0–EF can only be accessed through working registers and indirect addressing modes.

T16 Transmit Mode

In NORMAL or PING-PONG mode, the output of T16 when not enabled, is dependent on CTR1, D0. If it is a 0, T16_OUT is a 1; if it is a 1, T16_OUT is 0. You can force the output of T16 to either a 0 or 1 whether it is enabled or not by programming CTR1 D3; D2 to a 10 or 11.

When T16 is enabled, TC16H * 256 + TC16L is loaded, and T16_OUT is switched to its initial value (CTR1, D0). When T16 counts down to 0, T16_OUT is toggled (in NORMAL or PING-PONG mode), an interrupt (CTR2, D1) is generated (if enabled), and a status bit (CTR2, D5) is set. See Figure 25.
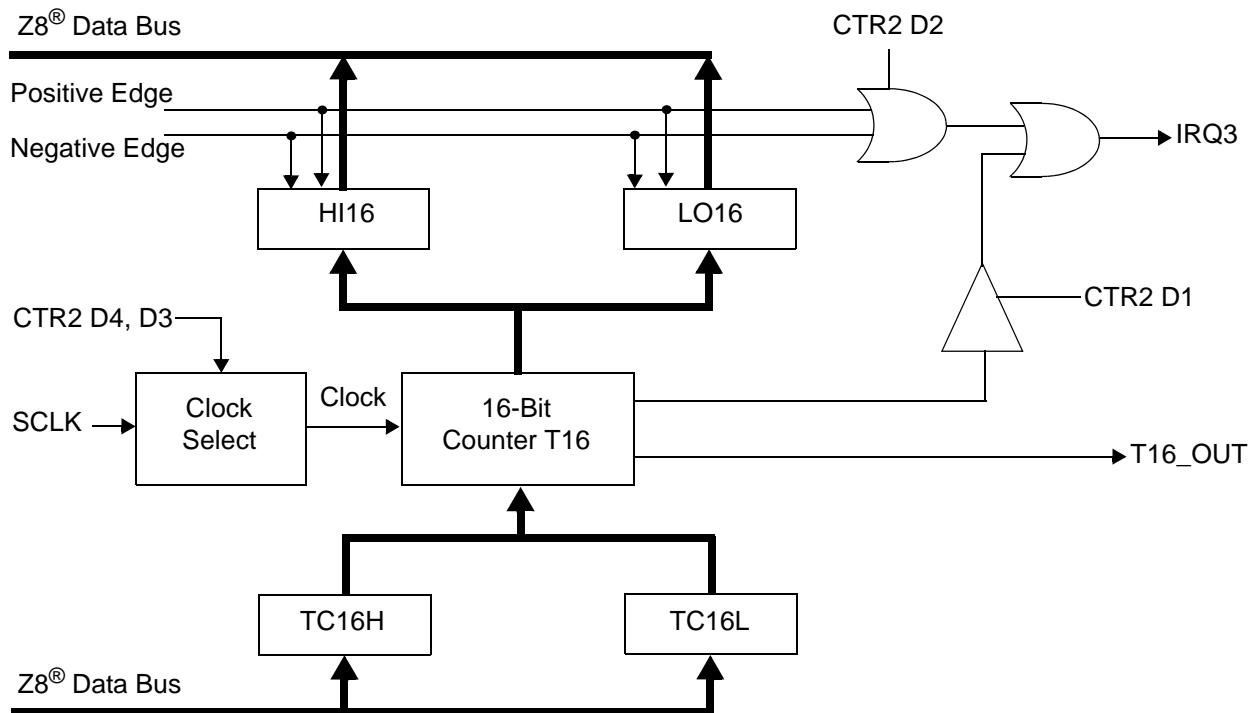

Figure 25. 16-Bit Counter/Timer Circuits

> **Note:** Global interrupts override this function as described in "Interrupts" on page 48.

If T16 is in SINGLE-PASS mode, it is stopped at this point (see Figure 26). If it is in Modulo-N Mode, it is loaded with TC16H * 256 + TC16L, and the counting continues (see Figure 27).

You can modify the values in TC16H and TC16L at any time. The new values take effect when they are loaded.

⚠️ **Caution:** Do not load these registers at the time the values are to be loaded into the counter/timer to ensure known operation. An initial count of 1 is not allowed. An initial count of 0 causes T16 to count from 0 to FFFFH to FFFEH. Transition from 0 to FFFFH is not a timeout condition.
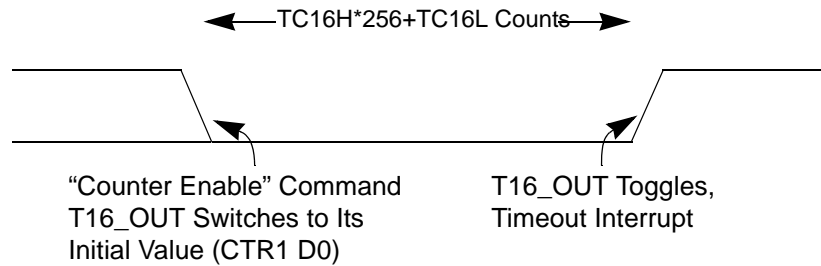

←——TC16H*256+TC16L Counts——→

"Counter Enable" Command T16_OUT Switches to Its Initial Value (CTR1 D0)

T16_OUT Toggles, Timeout Interrupt

Figure 26. T16_OUT in Single-Pass Mode

TC16H*256+TC16L

TC16H*256+TC16L

. . .

TC16_OUT

TC16H*256+TC16L

"Counter Enable" Command, T16_OUT Switches to Its Initial Value (CTR1 D0)

T16_OUT Toggles, Timeout Interrupt
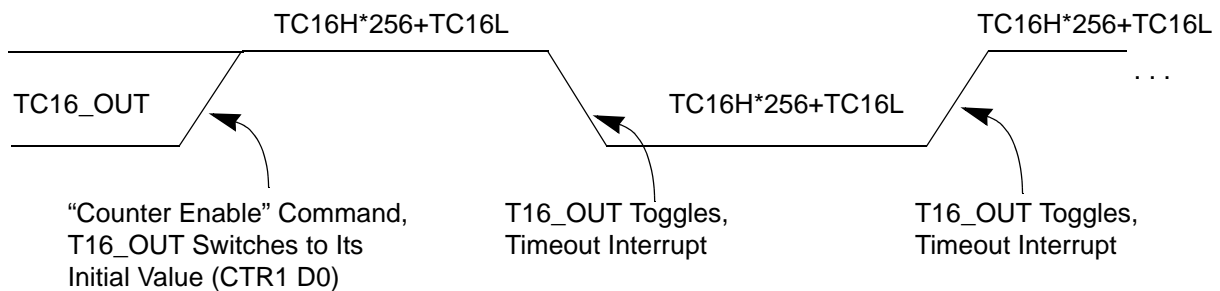
T16_OUT Toggles, Timeout Interrupt

Figure 27. T16_OUT in Modulo-N Mode

T16 DEMODULATION Mode

The user must program TC16L and TC16H to FFH. After T16 is enabled, and the first edge (rising, falling, or both depending on CTR1 D5; D4) is detected, T16 captures HI16 and LO16, reloads, and begins counting.

If D6 of CTR2 Is 0

When a subsequent edge (rising, falling, or both depending on CTR1, D5; D4) is detected during counting, the current count in T16 is complemented and put into HI16 and LO16. When data is captured, one of the edge detect status bits (CTR1, D1; D0) is set, and an interrupt is generated if enabled (CTR2, D2). T16 is loaded with FFFFH and starts again.

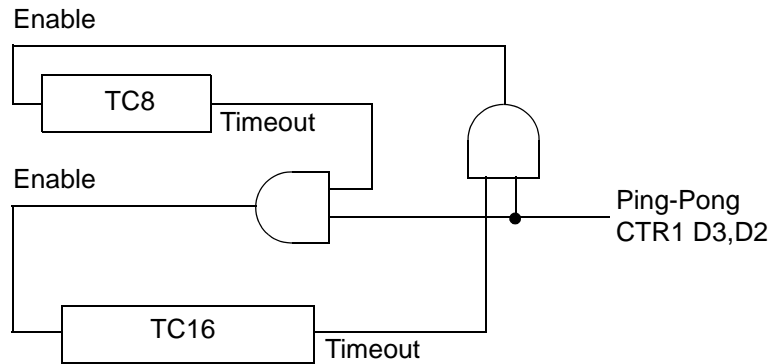This T16 mode is generally used to measure space time, the length of time between bursts of carrier signal (marks).

Figure 28. Ping-Pong Mode Diagram

Initiating PING-PONG Mode

First, make sure both counter/timers are not running. Set T8 into Single-Pass mode (CTR0, D6), set T16 into SINGLE-PASS mode (CTR2, D6), and set the Ping-Pong mode (CTR1, D2; D3). These instructions can be in random order. Finally, start PING-PONG mode by enabling either T8 (CTR0, D7) or T16 (CTR2, D7). See Figure 29.
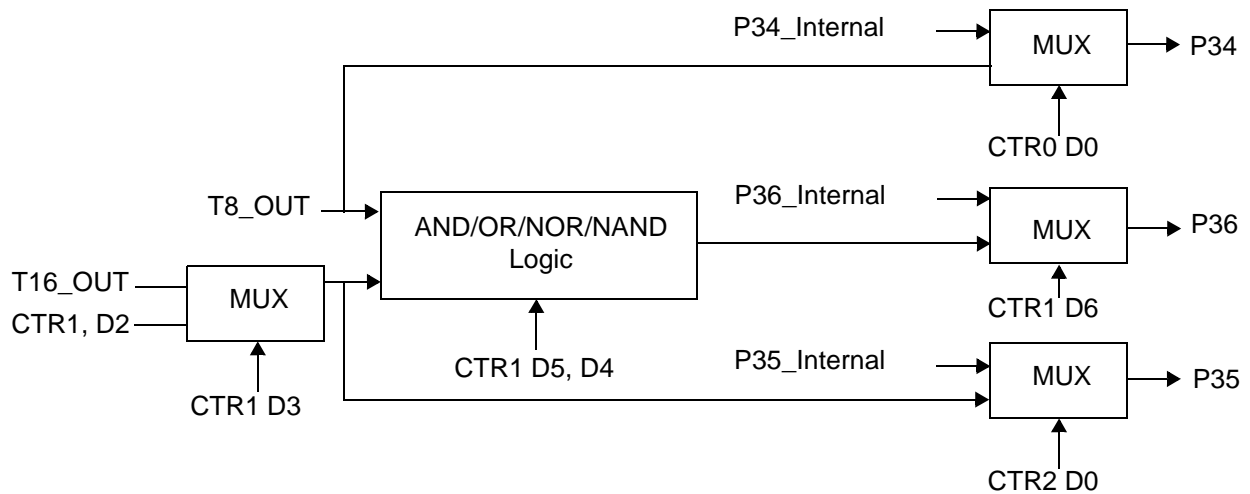

Figure 29. Output Circuit

The initial value of T8 or T16 must not be 1. Stopping the timer and restarting the timer reloads the initial value to avoid an unknown previous value.

During PING-PONG Mode

The enable bits of T8 and T16 (CTR0, D7; CTR2, D7) are set and cleared alternately by hardware. The timeout bits (CTR0, D5; CTR2, D5) are set every time the counter/timers reach the terminal count.

Timer Output

The output logic for the timers is illustrated in Figure 29. P34 is used to output T8-OUT when D0 of CTR0 is set. P35 is used to output the value of TI6-OUT when D0 of CTR2 is set. When D6 of CTR1 is set, P36 outputs the logic combination of T8-OUT and T16-OUT determined by D5 and D4 of CTR1.

Interrupts

The Z8 GP^{TM} OTP MCU Family features six different interrupts (Table 16). The interrupts are maskable and prioritized (Figure 30). The six sources are divided as follows: three sources are claimed by Port 3 lines P33–P31, two by the counter/timers (Table 16) and one for low voltage detection. The Interrupt Mask Register (globally or individually) enables or disables the six interrupt requests.

The source for IRQ is determined by bit 1 of the Port 3 mode register (P3M). When in digital mode, Pin P33 is the source. When in analog mode the output of the Stop mode recovery source logic is used as the source for the interrupt. See Figure 35, Stop Mode Recovery Source, on page 57.

```
FF          NOP          ; clear the pipeline
6F          Stop         ; enter Stop Mode
```
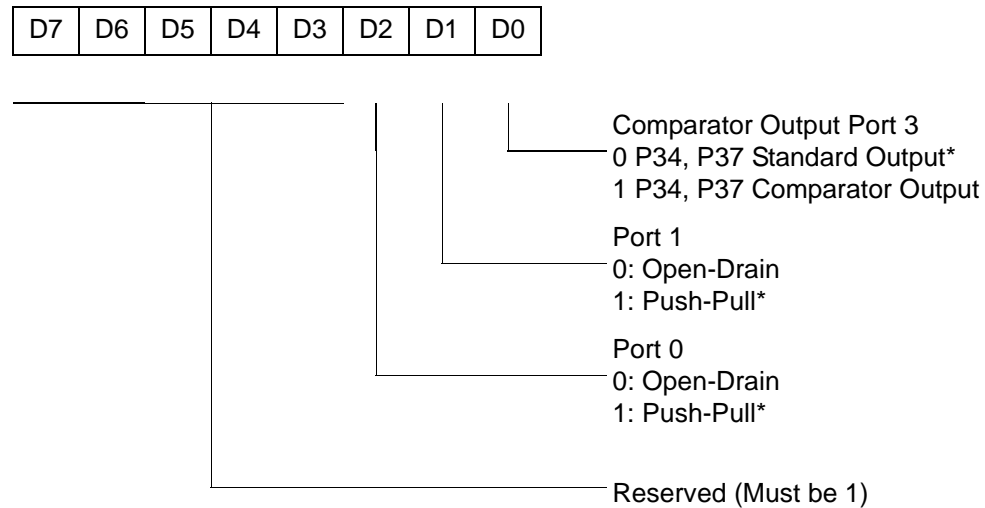
or

```
FF          NOP          ; clear the pipeline
7F          HALT         ; enter HALT Mode
```

Port Configuration Register

The Port Configuration (PCON) register (Figure 32) configures the comparator output on Port 3. It is located in the expanded register 2 at Bank F, location 00.

PCON(FH)00H

D7	D6	D5	D4	D3	D2	D1	D0

Comparator Output Port 3
0 P34, P37 Standard Output*
1 P34, P37 Comparator Output

Port 1
0: Open-Drain
1: Push-Pull*

Port 0
0: Open-Drain
1: Push-Pull*

Reserved (Must be 1)

 * Default setting after reset

Figure 32. Port Configuration Register (PCON) (Write Only)

Comparator Output Port 3 (D0)

Bit 0 controls the comparator used in Port 3. A 1 in this location brings the comparator outputs to P34 and P37, and a 0 releases the Port to its standard I/O configuration.

Port 1 Output Mode (D1)

Bit 1 controls the output mode of port 1. A 1 in this location sets the output to push-pull, and a 0 sets the output to open-drain.
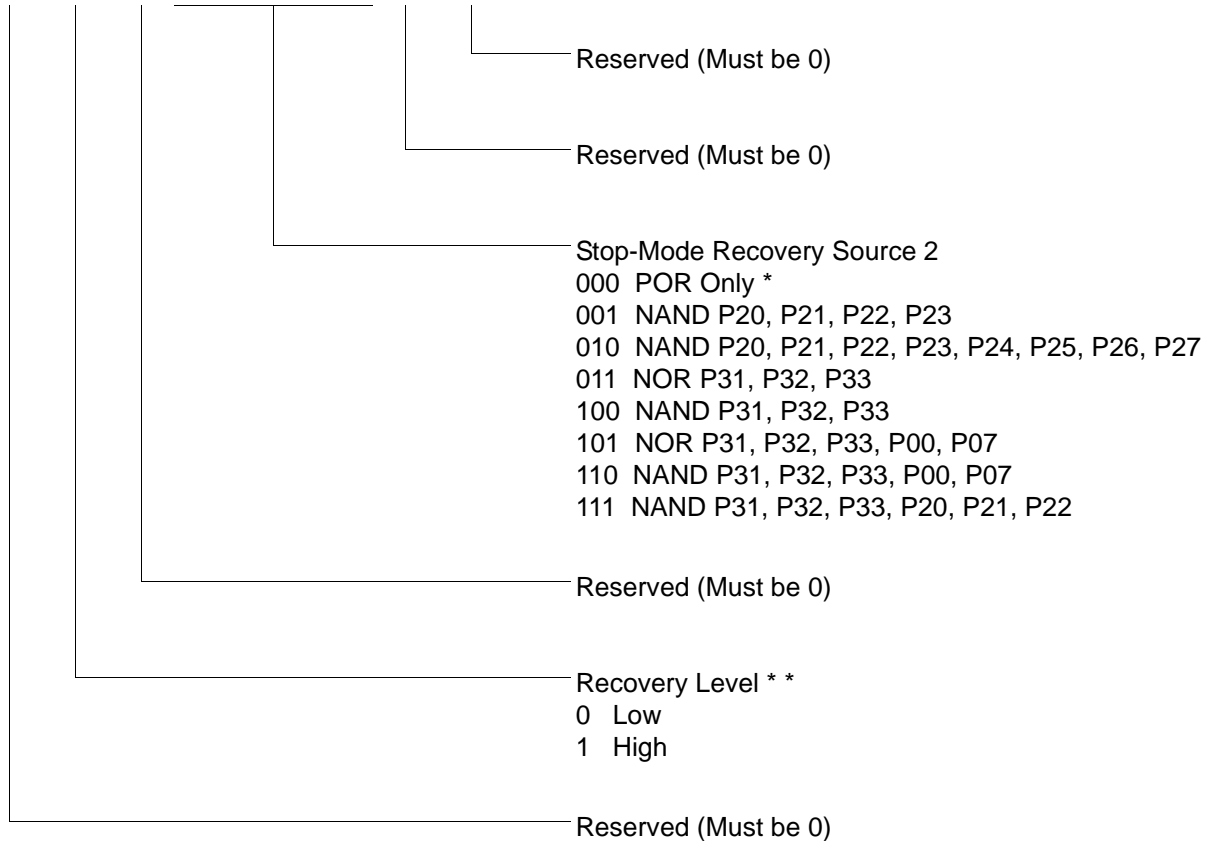
Port 0 Output Mode (D2)

Bit 2 controls the output mode of port 0. A 1 in this location sets the output to push-pull, and a 0 sets the output to open-drain.

Stop-Mode Recovery Register (SMR)

This register selects the clock divide value and determines the mode of Stop Mode Recovery (Figure 33). All bits are write only except bit 7, which is read only. Bit 7 is a flag bit that is hardware set on the condition of Stop recovery and reset by a power-on cycle. Bit 6 controls whether a low level or a high level at the XOR-gate input (Figure 35 on page 57) is required from the recovery source. Bit 5 controls the reset delay after recovery. Bits D2, D3, and D4 of the SMR register specify the source of the Stop Mode Recovery signal. Bits D0 determines if SCLK/TCLK are divided by 16 or not. The SMR is located in Bank F of the Expanded Register Group at address `0BH`.

SMR2(0F)0DH

D7	D6	D5	D4	D3	D2	D1	D0

Reserved (Must be 0)

Reserved (Must be 0)

Stop-Mode Recovery Source 2
000 POR Only *
001 NAND P20, P21, P22, P23
010 NAND P20, P21, P22, P23, P24, P25, P26, P27
011 NOR P31, P32, P33
100 NAND P31, P32, P33
101 NOR P31, P32, P33, P00, P07
110 NAND P31, P32, P33, P00, P07
111 NAND P31, P32, P33, P20, P21, P22

Reserved (Must be 0)

Recovery Level * *
0 Low
1 High

Reserved (Must be 0)

Note: If used in conjunction with SMR, either of the two specified events causes a Stop-Mode Recovery.
* Default setting after reset
* * At the XOR gate input

Figure 46. Stop Mode Recovery Register 2 ((0F)0DH:D2–D4, D6 Write Only)
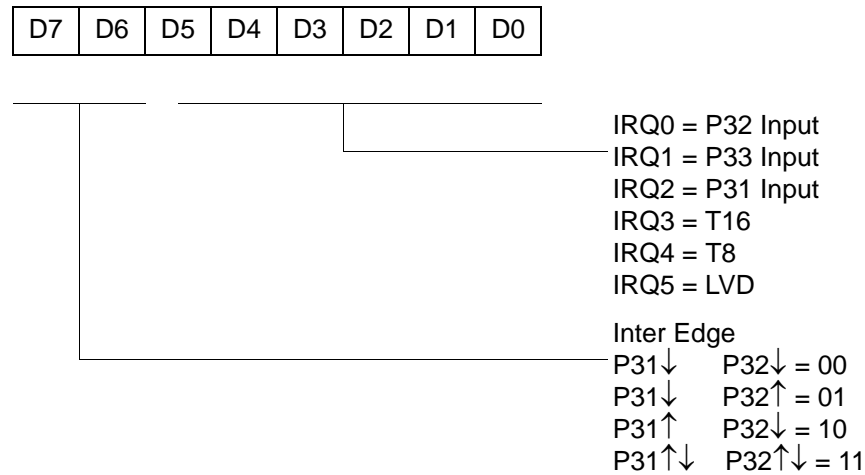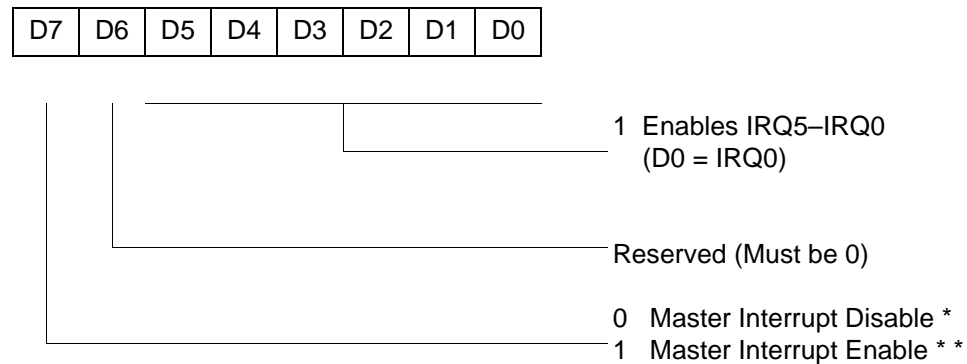
R250 IRQ(FAH)

D7	D6	D5	D4	D3	D2	D1	D0

IRQ0 = P32 Input
IRQ1 = P33 Input
IRQ2 = P31 Input
IRQ3 = T16
IRQ4 = T8
IRQ5 = LVD

Inter Edge
P31↓   P32↓ = 00
P31↓   P32↑ = 01
P31↑   P32↓ = 10
P31↑↓ P32↑↓ = 11

Figure 52. Interrupt Request Register (FAH: Read/Write)

R251 IMR(FBH)

D7	D6	D5	D4	D3	D2	D1	D0

1 Enables IRQ5–IRQ0
   (D0 = IRQ0)

Reserved (Must be 0)

0   Master Interrupt Disable *
1   Master Interrupt Enable * *

 * Default setting after reset
 * * Only by using EI, DI instruction; DI is required before changing the IMR register

Figure 53. Interrupt Mask Register (FBH: Read/Write)

R254 SPH(FEH)

D7	D6	D5	D4	D3	D2	D1	D0

General-Purpose Register

Figure 56. Stack Pointer High (FEH: Read/Write)

R255 SPL(FFH)

D7	D6	D5	D4	D3	D2	D1	D0

Stack Pointer Low
Byte (SP7–SP0)

Figure 57. Stack Pointer Low (FFH: Read/Write)

Ordering Information

32KB Standard Temperature: 0° to +70°C

Part Number	Description	Part Number	Description
ZGP323LSH4832C	48-pin SSOP 32K OTP	ZGP323LSS2832C	28-pin SOIC 32K OTP
ZGP323LSP4032C	40-pin PDIP 32K OTP	ZGP323LSH2032C	20-pin SSOP 32K OTP
ZGP323LSH2832C	28-pin SSOP 32K OTP	ZGP323LSP2032C	20-pin PDIP 32K OTP
ZGP323LSP2832C	28-pin PDIP 32K OTP	ZGP323LSS2032C	20-pin SOIC 32K OTP
ZGP323LSK2032E	20-pin CDIP 32K OTP	ZGP323LSK4032E	40-pin CDIP 32K OTP
		ZGP323LSK2832E	28-pin CDIP 32K OTP

32KB Extended Temperature: -40° to +105°C

Part Number	Description	Part Number	Description
ZGP323LEH4832C	48-pin SSOP 32K OTP	ZGP323LES2832C	28-pin SOIC 32K OTP
ZGP323LEP4032C	40-pin PDIP 32K OTP	ZGP323LEH2032C	20-pin SSOP 32K OTP
ZGP323LEH2832C	28-pin SSOP 32K OTP	ZGP323LEP2032C	20-pin PDIP 32K OTP
ZGP323LEP2832C	28-pin PDIP 32K OTP	ZGP323LES2032C	20-pin SOIC 32K OTP

32KB Automotive Temperature: -40° to +125°C

Part Number	Description	Part Number	Description
ZGP323LAH4832C	48-pin SSOP 32K OTP	ZGP323LAS2832C	28-pin SOIC 32K OTP
ZGP323LAP4032C	40-pin PDIP 32K OTP	ZGP323LAH2032C	20-pin SSOP 32K OTP
ZGP323LAH2832C	28-pin SSOP 32K OTP	ZGP323LAP2032C	20-pin PDIP 32K OTP
ZGP323LAP2832C	28-pin PDIP 32K OTP	ZGP323LAS2032C	20-pin SOIC 32K OTP

Note: Replace C with G for Lead-Free Packaging

4KB Standard Temperature: 0° to +70°C

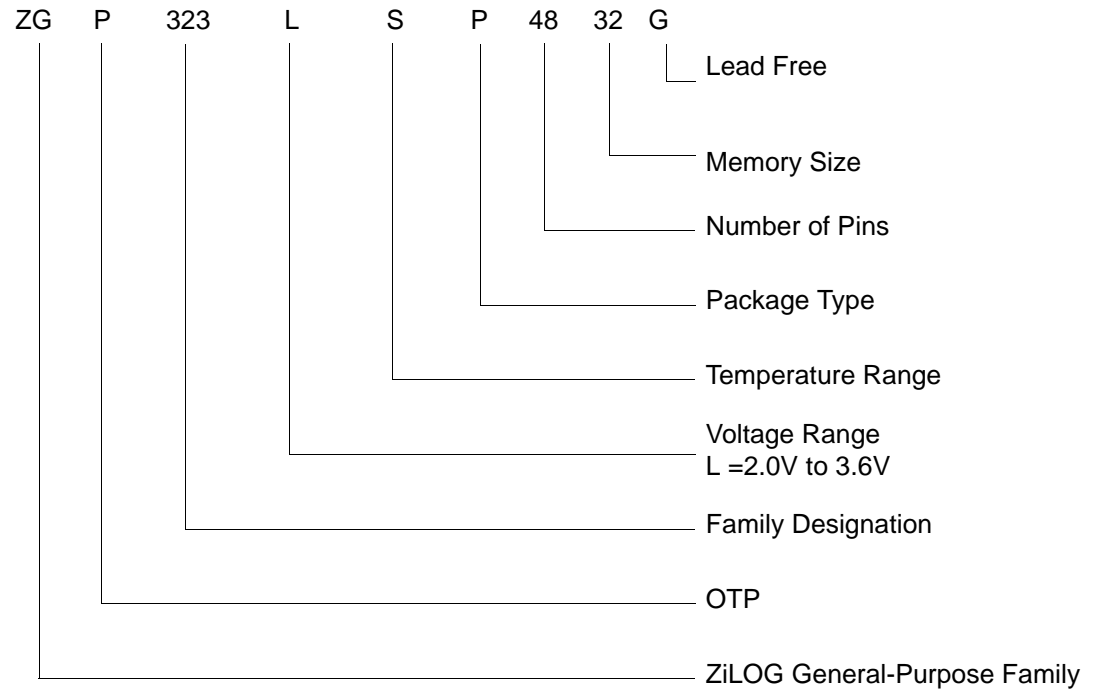| Part Number	Description	Part Number	Description
ZGP323LSH4804C	48-pin SSOP 4K OTP	ZGP323LSS2804C	28-pin SOIC 4K OTP
ZGP323LSP4004C	40-pin PDIP 4K OTP	ZGP323LSH2004C	20-pin SSOP 4K OTP
ZGP323LSH2804C	28-pin SSOP 4K OTP	ZGP323LSP2004C	20-pin PDIP 4K OTP
ZGP323LSP2804C	28-pin PDIP 4K OTP	ZGP323LSS2004C	20-pin SOIC 4K OTP

4KB Extended Temperature: -40° to +105°C

Part Number	Description	Part Number	Description
ZGP323LEH4804C	48-pin SSOP 4K OTP	ZGP323LES2804C	28-pin SOIC 4K OTP
ZGP323LEP4004C	40-pin PDIP 4K OTP	ZGP323LEH2004C	20-pin SSOP 4K OTP
ZGP323LEH2804C	28-pin SSOP 4K OTP	ZGP323LEP2004C	20-pin PDIP 4K OTP
ZGP323LEP2804C	28-pin PDIP 4K OTP	ZGP323LES2004C	20-pin SOIC 4K OTP

4KB Automotive Temperature: -40° to +125°C

Part Number	Description	Part Number	Description
ZGP323LAH4804C	48-pin SSOP 4K OTP	ZGP323LAS2804C	28-pin SOIC 4K OTP
ZGP323LAP4004C	40-pin PDIP 4K OTP	ZGP323LAH2004C	20-pin SSOP 4K OTP
ZGP323LAH2804C	28-pin SSOP 4K OTP	ZGP323LAP2004C	20-pin PDIP 4K OTP
ZGP323LAP2804C	28-pin PDIP 4K OTP	ZGP323LAS2004C	20-pin SOIC 4K OTP

Note: Replace C with G for Lead-Free Packaging

Additional Components

Part Number	Description	Part Number	Description
ZGP323ICE01ZEM	Emulator/programmer	ZGP32300100ZPR	Programming System

Example

ZG   P   323   L   S   P   48   32   G

                                 Lead Free

                                 Memory Size

                                 Number of Pins

                                 Package Type

                                 Temperature Range

                                 Voltage Range
                                 L =2.0V to 3.6V

                                 Family Designation

                                 OTP

                                 ZiLOG General-Purpose Family